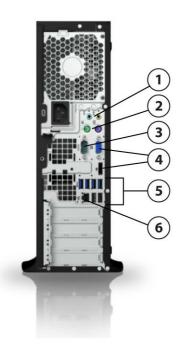
Overview

### **HP Z220 SFF Workstation**



- 1. External 5.25" bay
- 2. External/internal shared 3.5" bay
- 3. Power button
- 4.. Front I/O (in top to bottom order): 4 USB 2.0 port, Headphone, Microphone
- 5. SFF tower stand (optional)

### Overview



- 1. 1 Audio Line In, 1 Audio Line Out
- 2. PS/2 ports (keyboard, mouse)
- 3. 1 serial port
- 4. 1 VGA, 1 DisplayPort (DP 1.1) output from Intel HD graphics (available on specific processors only)
- 5. 4 USB 3.0, 2 USB 2.0
- 6. RJ-45 to integrated GBE

Form Factor	Small Form Factor
Operating Systems	Preinstalled:
	<ul> <li>Windows 7 Professional 32/64</li> <li>HP Installer Kit for Linux [includes drivers for 64-bit OS versions of Red Hat Enterprise Linux 6 and SUSE Linux Enterprise Desktop (SLED) 11]</li> <li>Windows 8 Pro 64-bit</li> <li>Windows 8 Simplified Chinese Edition 64-bit</li> <li>Windows 8 Pro Downgrade to Windows 7 Professional 32-bit</li> <li>Windows 8 Pro Downgrade to Windows 7 Professional 64-bit</li> <li>SUSE Linux Enterprise Desktop 11 64-bit (90 day license)</li> <li>Red Hat Enterprise Linux Workstation (1 year paper license available; Preinstall not available)</li> </ul>
	Supported:
	<ul> <li>Genuine Windows® 7 Enterprise 32/64</li> <li>Genuine Windows® XP Professional 32/64*</li> </ul>
	Notes: *See the "Windows XP Support Matrix for Z Workstations" at:

#### Overview

http://www.hp.com/support/workstation\_manuals

**Notes:** For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux\_hardware\_matrix

Name	Cores	Clock Speed (GHz)	Intel® Turbo Boost Technology¹	Cache (MB)	Memory Speed (MT/s)	Hyper- Threading	Integrated Graphics	Featuring Intel® vPro™ Technology	TDP (W)
Intel® Xeon®	İ								
processor E3-1280v2	4	3.6	4.0	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1270v2	4	3.5	3.9	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1245v2	4	3.4	3.8	8	1600	Y	Intel HD Graphics P4000	Y	77W
Intel® Xeon® processor E3-1240v2	4	3.4	3.8	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1230v2	4	3.3	3.7	8	1600	Y	N/A	Y	69W
Intel® Xeon® processor E3-1225v2	4	3.2	3.6	8	1600	N	Intel HD Graphics P4000	Y	77W
Intel® Core™ i7- 3770 processor	4	3.4	3.9	8	1600	Y	Intel HD Graphics 4000	Y	77W
Intel® Core™ i5- 3570 processor	4	3.4	3.8	6	1600	N	Intel HD Graphics 2500	Y	77W
Intel® Core™ i5- 3470 processor	4	3.2	3.6	6	1600	N	Intel HD Graphics 2500	Y	77W
Intel® Core™ i3- 3240 processor	2	3.4	N/A		1600	N	Intel HD Graphics 2500	N	55W
Intel® Core™ i3- 3220 processor	2	3.3	N/A		1600	N	Intel HD Graphics 2500	N	55W
Intel® Core™ i3- 2120 processor	2	3.3	N/A	3	1333	N	Intel HD Graphics 2000	M	65W
Intel® Pentium® G2020 processor	2	2.9	N/A	3	1066	N	Intel HD Graphics	N	55W

<sup>1</sup>The specifications shown in this column represent the maximum turbo frequency with one core active. Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A.

#### Available Processor Disclaimers

Integrated Intel® HD graphics is not supported on the Intel® Xeon E3-1230v2, E3-1240v2, E3-1270v2 or E3-1280v2 Processors.

Intel® Xeon E3, Intel Core i3 and Intel Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.

Intel's numbering is not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See:



### Overview

http://www.intel.com/products/processor_number/ for details. 64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: <a href="http://www.intel.com/info/em64t">http://www.intel.com/info/em64t</a> for more information.  Dual-Core and Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.  Jack Black  The Z220 SFF can either be placed flat on the desktop or made to stand on the desk with the optional tower stand.  1 PCIe Gen3 x16 slot 1 PCIe Gen2 x4 slot /x16 connector 1 PCIe Gen2 x4 slot /x16 connector 1 PCIe Gen2 x1 slot 1 PCI (all slots are Low Profile)  NOTE: In the PCIe Gen3 x16 slot, if it is not being used for a graphics card, only cards certified as After Market Options for this platform are supported. 1 internal 3.5" bay, and 1 shared internal/external 3.5" bay. 1 external 5.25" bay.  4 USB 2.0, 1 Headphone, and 1 Microphone 4 USB 2.0 ports available by two separate 9-pin headers 1 VGA and 1 DisplayPort (DP 1.1)output from Intel HD graphics (available on specific processors only); 4 USB 3.0 ports, 2 USB 2.0 ports, 1 standard and 1 optional serial port, 1 optional parallel port, 2 PS/2, RJ-45 (NIC), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports(optional).  22-in-1 Media Card Reader (optional)
The Z220 SFF can either be placed flat on the desktop or made to stand on the desk with the optional tower stand.  • 1 PCIe Gen3 x16 slot • 1 PCIe Gen2 x4 slot /x16 connector • 1 PCIe Gen2 x1 slot • 1 PCI • (all slots are Low Profile)  **NOTE: In the PCIe Gen3 x16 slot, if it is not being used for a graphics card, only cards certified as After Market Options for this platform are supported.  • 1 internal 3.5" bay, and 1 shared internal/external 3.5" bay. • 1 external 5.25" bay.  4 USB 2.0, 1 Headphone, and 1 Microphone  4 USB 2.0 ports available by two separate 9-pin headers  1 VGA and 1 DisplayPort (DP 1.1)output from Intel HD graphics (available on specific processors only); 4 USB 3.0 ports, 2 USB 2.0 ports, 1 standard and 1 optional serial port, 1 optional parallel port, 2 PS/2, RJ-45 (NIC), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports(optional).
tower stand.  • 1 PCIe Gen3 x16 slot • 1 PCIe Gen2 x4 slot /x16 connector • 1 PCIe Gen2 x1 slot • 1 PCI (all slots are Low Profile)  NOTE: In the PCIe Gen3 x16 slot, if it is not being used for a graphics card, only cards certified as After Market Options for this platform are supported.  • 1 internal 3.5" bay, and 1 shared internal/external 3.5" bay. • 1 external 5.25" bay.  4 USB 2.0, 1 Headphone, and 1 Microphone  4 USB 2.0 ports available by two separate 9-pin headers  1 VGA and 1 DisplayPort (DP 1.1)output from Intel HD graphics (available on specific processors only); 4 USB 3.0 ports, 2 USB 2.0 ports, 1 standard and 1 optional serial port, 1 optional parallel port, 2 PS/2, RJ-45 (NIC), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports(optional).
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<ul> <li>1 internal 3.5" bay, and 1 shared internal/external 3.5" bay.</li> <li>1 external 5.25" bay.</li> <li>4 USB 2.0, 1 Headphone, and 1 Microphone</li> <li>4 USB 2.0 ports available by two separate 9-pin headers</li> <li>1 VGA and 1 DisplayPort (DP 1.1)output from Intel HD graphics (available on specific processors only); 4 USB 3.0 ports, 2 USB 2.0 ports, 1 standard and 1 optional serial port, 1 optional parallel port, 2 PS/2, RJ-45 (NIC), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports(optional).</li> </ul>
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1 VGA and 1 DisplayPort (DP 1.1)output from Intel HD graphics (available on specific processors only); 4 USB 3.0 ports, 2 USB 2.0 ports, 1 standard and 1 optional serial port, 1 optional parallel port, 2 PS/2, RJ-45 (NIC), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports(optional).
USB 3.0 ports, 2 USB 2.0 ports, 1 standard and 1 optional serial port, 1 optional parallel port, 2 PS/2, RJ-45 (NIC), 1 Audio Line-in, and 1 Audio Line-out; 2 IEEE 1394b ports(optional).
22-in-1 Media Card Reader (ontional)
22 III T Pledid Card Nedder (Optional)
Standard desktop orientation: 100 x 338 x 384 mm (3.95 x 13.3 x 15.1 in); Optional SFF Tower
orientation (excluding stand dimension): 338 x 100 x 381 mm (13.3 x 3.95 x 15.0 in)
Exact weights depend upon configuration; Typical Weight* 7.5 kg (16.5 lbs) Shipping Weight* 8.1 kg (17.86 lbs) Max Supported Weight (desktop orientation) 35 kg (77 lb)  *Configured with 1 3.5" hard drive, 1 optical drive, 2 DIMMs and 1 NVIDIA NVS 300 graphics card
Operating: 40° to 95°F (5° to 35°C) Non-operating: -40° to 140°F (-40° to 60°C)
Operating: 8% to 85% Non-operating: 8% to 90%
Operating: 3,000 m (10,000 ft)
Non-operating: 9,100 m (30,000 ft).
240 watts wide-ranging, active Power Factor Correction, 90% Efficient  The Power Supply Efficiency Report for this product may be found at these links: <a href="http://www.pluqloadsolutions.com/psu_reports/HEWLETT-PACKARD_PS-4241-9HB_ECOS%202398_240W_Report.pdf">http://www.pluqloadsolutions.com/psu_reports/HEWLETT-PACKARD_PC9055-</a> http://www.pluqloadsolutions.com/psu_reports/HEWLETT-PACKARD_PC9055-



### Overview

	http://www.pluqloadsolutions.com/psu_reports/HEWLETT-PACKARD%20COMPANY_D10- 240P1A_ECOS%202307_240W_Report.pdf  http://www.pluqloadsolutions.com/psu_reports/HP_DPS- 240TB%20A_ECOS%202299_240W_Report.pdf  http://www.pluqloadsolutions.com/psu_reports/HEWLETT-
Backup Devices	PACKARD%20COMPANY_CFH240EWWB_ECOS%202304_240W_Report.pdf  For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup
•	System offerings, please visit: <a href="http://www.hp.com/qo/connect">http://www.hp.com/qo/connect</a>
Chipset	Intel® C216 chipset
Memory	4 DIMM slots, supporting up to 32GB ECC/non-ECC, DDR3 1600 MT/s
Memory disclaimers	The CPUs determine the speed at which the memory is clocked. If a 1066 MT/s capable CPU is used in the system, the maximum speed the memory will run at is 1066 MHz regardless of the specified speed of the memory.
Workstation ISV Certifications	See the latest list of certifications at: http://www.hp.com/united-states/campaigns/workstations/partnerships.html



### **Supported Components**

**Processors** 

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Intel® Xeon® processor E3 v2 family (Z220)				
Intel® Xeon® processor E3-1280v2, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0 GHz with Intel Turbo Boost Technology	Υ	N		See Note 2
Intel® Xeon® processor E3-1270v2, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology	Υ	N		See Note 2
Intel® Xeon® processor E3-1245v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology	Υ	N		See Note 2
Intel® Xeon® processor E3-1240v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology	Υ	N		See Note 2
Intel® Xeon® processor E3-1230v2, Quad-Core, 8 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology	Υ	N		See Note 2
Intel® Xeon® processor E3-1225v2, Quad-Core, 8 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology	Υ	N		See Note 2
3rd generation Intel® Core™ processor family				
Intel® Core™ i7-3770 processor, Quad-Core, 8 MB cache, 3.4GHz, up to 3.9 GHz with Intel Turbo Boost Technology	Υ	N		See Note 3
Intel® Core™ i5-3570 processor, Quad-Core, 6 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology	Y	N		See Note 3
Intel® Core™ i5-3470 processor, Quad-Core, 6 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology	Y	N		See Note 3
Intel® Core™ i3-3240 processor, Dual-Core, 3 MB cache, 3.4 GHz	Υ	N		See Note 2
Intel® Core™ i3-3220 processor, Dual-Core, 3 MB cache, 3.3 GHz	Υ	N		See Note 2
Dual-Core Intel® Pentium® processors (Z220)				
Intel® Pentium® G2020 processor, Dual-Core, 3 MB cache 2.9 GHz	, Y	N		See Note 2

**NOTE 1:** Intel HD Graphics P4000 provides improved desktop performance and supports workstation-specific graphics drivers for improved compatibility and performance on select professional applications\*, compared to Intel HD Graphics 4000 or Intel HD Graphics 2500.

NOTE 2: These processors support either ECC or non-ECC memory

**NOTE 3:** These processors support only non-ECC memory

Monitors / Displays	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP DreamColor LP2480zx Professional Display				

HP DreamColor LP2480zx Professional Displa HP ZR30w 30-inch S-IPS LCD Monitor HP ZR2740w 27-inch LED Backlit IPS Monitor HP ZR24w 24-inch S-IPS LCD Monitor



### **Supported Components**

HP ZR2440w 24-inch LED Backlit IPS Monitor
HP ZR2240w 21.5-inch LED Backlit IPS Monitor
HP ZR2040w 20-inch LED Backlit IPS Monitor

Supported by all Operating Systems available from HP

Screen Size Diagonally Measured

#### **Hard Drives**

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA (Serial ATA) Hard Drives for HP Workstations				
	250GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ034AA	
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA	
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA	
	250GB SATA 10K rpm SFF HDD	Υ	Υ	B8X18AA	
	500GB SATA 10K rpm SFF HDD	Υ	Υ	B8X19AA	
	1TB SATA 10K rpm SFF HDD	Υ	Υ	B8X20AA	
	500GB SATA 7.2K SED SFF HDD	Y	N	(not available today as After Market Option)	
SATA Solid State Drives	HP Solid State Drives (SSDs) for Workstations				
	HP 128GB SATA 6Gb/s SSD	Υ	Υ	A3D25AA	
	HP 256GB SATA 6Gb/s SSD	Υ	Υ	A3D26AA	
	HP 256GB SATA 6Gb/s SED SSD	Υ	Υ	D8N28AA	
	HP 512GB SATA 6Gb/s SSD	Υ	Υ	D8F30AA	
	Intelligent Disk Caching				
	24GB SSD Disk Cache Module	Υ	N		

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated SATA Controller (Z220)				
	Integrated SATA Controller (SFF), RAID 0,1 supported: 2 ports 3 Gb/s, 2 ports 6 Gb/s	Υ	N		
	Factory integrated RAID on motherboard for SATA drives	5			
	RAID 0 Configuration - Striped Array	Υ	N		
	RAID 1 Configuration - Mirrored Array	Υ	N		

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit:

http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.

All drives must be identical in type and capacity.



### **Supported Components**

Boot/OS volume if configured as RAID array must be less than 2 TB. **NOTE 1:** Requires identical hard drives (speeds, capacity, interface).

Graphics				Option		Supported		
		Factory Configured	Option Kit	Kit Part Number	Support Notes	# of cards	Mixed?	
	Integrated Intel HD Graphics Media	_		Hamber	Motes	cuius	· iiiicu.	
	Intel HD Graphics P4000	Υ	N		Supported on Intel Xeon E3- 12x5v2 processors only.	1	NO	
	Intel HD Graphics 4000	Y	N		Supported on Intel Core i7- 3xxx processors only.	1	NO	
	Intel HD Graphics 2500	Y	N		Supported on Intel Core i5- 3xxx and Core i3- 3xxx processors only	1	NO	
	Intel HD Graphics  Professional 2D	Y	N		Supported on Pentium G6xx processors. Even though graphics on this part is branded as Intel HD Graphics, it is similar to Intel HD Graphics 2000 but lacks some premium media capabilities.	1	NO	
	NVIDIA NVS300 512MB Graphics	Υ	Υ	XP612AA		2	NO	
	NVIDIA NVS 310 512MB Graphics	Υ	Υ	A7U59AA		2	NO	
	NVIDIA NVS 510 2GB Graphics	Υ	Υ	C2J98AA	Can be mixed with	1	Yes	



### **Supported Components**

AMD FirePro V3900 1GB Graphics	Υ	Υ	A6R69AA	1	NO
NVIDIA Quadro K600 1GB Graphics	Υ	Υ	C2J92AA	1	NO
NVIDIA Quadro 410 512MB Graphics	Υ	Υ	A7U60AA	1	NO

Intermixing integrated Intel HD graphics and discrete graphics cards in order to drive more than two displays can be enabled using the Computer (F10) Setup Utility. However, HP recommends using only discrete graphics cards when attaching three or more displays.

Graphics Cable				Option		Supported	
Adapters		Factory Configured	Option Kit	Kit Part Number	Support Notes	# of cards	Mixed?
	Graphics Cable Adapters						
	HP DisplayPort To DVI-D Adapter (2- Pack)	Υ	N			1	
	HP DisplayPort To VGA Adapter 2nd	Υ	N			1	
	HP DisplayPort To DVI-D Adapter (4- Pack)	Υ	N			1	
	HP DisplayPort To DVI-D Adapter (6- Pack)	Υ	N			1	
	HP DisplayPort To VGA Adapter	Υ	Υ	AS615AA		1	
	HP DisplayPort To DVI-D Adapter	Υ	Υ	FH973AA		1	
	HP DisplayPort to Dual Link DVI Adapter	Υ	Υ	NR078AA		1	

#### Memory

#### **Sub-Section Description/Notes**

Intel® Xeon E3, Intel Core i3 and Intel Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.

CTO Option Kit Part Support Notes
Number

#### DDR3-1600 nECC Unbuffered DIMMs CTO

HP 32GB (4x8GB) DDR3-1600 nECC RAM

HP 16GB (4x4GB) DDR3-1600 nECC RAM

HP 12GB (2x4GB+2x2GB) DDR3-1600 nECC RAM

HP 8GB (2x4GB) DDR3-1600 nECC RAM

HP 8GB (4x2GB) DDR3-1600 nECC RAM

HP 4GB (1x4GB) DDR3-1600 nECC RAM

HP 4GB (2x2GB) DDR3-1600 nECC RAM

HP 2GB (1x2GB) DDR3-1600 nECC RAM

#### DDR3-1600 ECC Unbuffered DIMMs - CTO

HP 32GB (4x8GB) DDR3-1600 ECC RAM

HP 16GB (4x4GB) DDR3-1600 ECC RAM

HP 12GB (2x4GB+2x2GB) DDR3-1600 ECC RAM

HP 8GB (2x4GB) DDR3-1600 ECC RAM

HP 8GB (4x2GB) DDR3-1600 ECC RAM

HP 4GB (2x2GB) DDR3-1600 ECC RAM

HP 4GB (1x4GB) DDR3-1600 ECC RAM

HP 2GB (1x2GB) DDR3-1600 ECC RAM

**Sub-Section Description/Notes** 



### **Supported Components**

Two channels of DDR3 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If a 1066 MT/s capable CPU is used in the system, the maximum speed the memory will run at is 1066 MT/s regardless of the specified speed of the memory.

АМО	Option Kit Part Number	Support Notes
DDR3-1600 nECC Unbuffered DIMMs AMO		
HP 8GB (1x8GB) DDR3-1600 non-ECC RAM	B1S54AA	
HP 4GB (1x4GB) DDR3-1600 nECC RAM	B1S53AA	
HP 2GB (1x2GB) DDR3-1600 nECC RAM	B1S52AA	
DDR3-1600 ECC Unbuffered DIMMs - AMO		
HP 8GB (1x8GB) DDR3-1600 ECC RAM	A2Z50AA	
HP 4GB (1x4GB) DDR3-1600 ECC RAM	A2Z48AA	
HP 2GB (1x2GB) DDR3-1600 ECC RAM	A2Z47AA	
<b>NOTE:</b> Only unbuffered DDR3 DIMMs are supported.		

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Thin USB Powered Speakers, BFR-PVC free	Υ	Υ	KK912AA	
	Integrated Realtek HD ALC221 Audio	Υ	N		

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 16X DVD-ROM SATA Drive (non Lightscribe)	Υ	Υ	AR629AA	
	HP 16X DVD+/-RW SuperMulti SATA Drive (non- Lightscribe)	Y	Υ	QS208AA	
	HP Blu-ray Writer	Υ	Υ	AR482AA	
	HP 22-in-1 Media Card Reader Kit (Workstations)	Υ	Υ	NK361AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Controller Cards		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP IEEE 1394b FireWire PCIe Card	Y	Υ	NK653AA	See Note 1
	HP USB 3.0 2x2 Port SuperSpeed PCIe x1 Card	N	Υ	QT587AA	See Note 2

**NOTE 1:** For the Z220 SFF Workstation, this card is only supported on Slots 1 or 2



### **Supported Components**

**NOTE 2:** Four USB 3.0 ports are available integrated on the motherboard (rear access). Integrated USB 3.0 ports are supported under Microsoft Windows 7 operating system only. The USB 3.0 2x2 Port SuperSpeed PCIe card is required if Microsoft Windows XP or Linux operating systems support is required (supported as AMO only).

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel 82579LM PCIe GbE Controller	Υ	N		
	Intel Gigabit CT Desktop NIC	Υ	Υ	FH969AA	
	Gigabit Ethernet server and network infrastructure is The Intel Gigabit CT NIC is supported on the following Microsoft Windows XP Pro 32-bit and 64-bit and Mic Red Hat Enterprise Linux(RHEL), SLED 11	g operating systen		l 64-bit vers	ions.
	NOTE 2: The integrated network connection is require	ed to support Inte	l vPro Tec	hnology.	
	NOTE 3: If AMT is enabled network teaming with the	built in LAN port is	not possi	ible.	

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Security Cable with Kensington Lock	N	Υ	PC766A	
	HP 2009 (SFF) Solenoid Lock and Hood Sensor	Υ	Υ		
	HP Business PC Security Lock Kit	N	Y	PV606AA	
Input Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP PS/2 Keyboard	Υ	Υ		
	HP USB Keyboard	Υ	Υ		
	HP USB CCID SmartCard Keyboard	Υ	Υ	BV813AA	
	HP 2.4GHz Wireless Keyboard & Mouse	N	Υ	NB896AA	
	HP USB Optical 3-Button Mouse	Υ	Υ	DY651A	
	HP USB 1000dpi Laser Mouse	Υ	Υ		
	HP PS/2 Mouse	Υ	Υ		
	HP USB Optical Mouse	Υ	Υ		
	HP SpaceExplorer 3D USB Controller	N	Υ	RY429AA	
Other Hardware				Option	

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP Power Cord Kit	N	Υ	DM293A	
HP Workstation Mouse Pad	Υ	N		Japan only
HP Serial Port Adapter	Υ	Υ	PA716A	
HP ENERGY STAR 5.0 Enabled Configuration	Υ	N		



### **Supported Components**

HP Parallel Port Adapter Kit	N	Υ	KD061AA
HP Internal USB Port Kit	N	Υ	
HP eSATA PCI Cable Kit	Υ	Υ	FH966AA
HP 2009 (SFF) Chassis Tower Stand	Υ	Υ	VN569AA

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Υ	N		See Note 1
	HP Remote Graphics Software (RGS) V5	Υ	N		See Note 2
	HP ProtectTools Security	Υ	N		See Note 3
	PDF Complete - Corporate Edition	Υ	N		
	HP Support Assistant	Υ	N		
	HP Power Assistant	Υ	N		
	Cyberlink PowerDVD / Power2Go	Y	N		Media playback and authoring software
	MS Office Home & Business 2013	Υ	N		See Note 3

**NOTE 1:** Supports Windows 7 only. Preinstalled with every Windows 7 order; Also available as a free download from <a href="https://www.hp.com/go/performanceadvisor">www.hp.com/go/performanceadvisor</a>

**NOTE 2:** Supports both 32 and 64 bit versions of Windows 7 Professional and Enterprise, Windows XP Professional and Enterprise, and RHEL 6

**NOTE 3**: Must be selected as a Configure to Order option. Delivered in the form of a "Drop in the Box" CD.

### **Operating Systems**

### Support Notes

Genuine Windows® 7 Ultimate 64-bit Genuine Windows® 7 Professional 32-bit

See <a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> for support details.

defiultie willdows 7 Professional 32-0

See <a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> for support details.

Genuine Windows® 7 Professional 64-bit

See http://www.microsoft.com/windows/windows-7/

Genuine Windows® 7 Home Premium 64-bit

Genuine Windows® 7 Home Premium 32-bit

for support details.
See <a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> for support details.

Windows 8 Pro 64-bit

Windows 8 Simplified Chinese Edition 64-bit Windows 8 Pro Downgrade to Windows 7

Professional 32-bit

Windows 8 Pro Downgrade to Windows 7

Professional 64-bit HP Linux Installer Kit

Red Hat Enterprise Linux (RHEL)

See: <a href="http://www.hp.com/workstations/software/linux">http://www.hp.com/workstations/software/linux</a>
See <a href="http://www.redhat.com/rhel/desktop/">http://www.hp.com/workstations/software/linux</a>



### **Supported Components**

Workstation - Paper License (1yr) SUSE Linux Enterprise Desktop 11

See <a href="http://www.suse.com/products/desktop/">http://www.suse.com/products/desktop/</a>

Windows XP Pro 32-bit/64-bit OS supported. Drivers available on HP support web site.



System Board				
System Board Form Factor	BTX 21.2mm x 26.7mm	TX 21.2mm x 26.7mm		
Processor Socket	Single LGA 1155			
CPU Bus Speed	DMI			
Chipset	Intel® PCH C216			
Memory Expansion Slots	4 DDR3 memory slots			
Memory Type Supported	DDR3, UDIMM (Unbuffered), ECC & non-	ECC		
Memory Modes	Non-Interleaved for single channel. Inte	erleaved when both channels are populated.		
Memory Speed Supported	1600MT/s DDR3			
Memory Protection	ECC available on data			
Maximum Memory	32GB	lGB		
Memory Configuration	· · ·	ouffered DIMMs are supported, but not if mixed.		
(Supported)	Windows® 7 Professional 64-Bit and Re	<b>OTES:</b> Maximum memory capacities assume 64-bit operating systems, such as genuine Genuine indows® 7 Professional 64-Bit and Red Hat Linux 64-bit. Genuine Windows Vista Home 32 and XP ofessional (32-bit) support up to 4 GB. 32-bit Linux supports up to 8 GB.		
PCI Express Connectors	1 PCI Express Gen3 x16 LP slot (x16 electrical/x16 mechanical) 1 PCI Express Gen2 x16 LP slot (x4 electrical/x16 mechanical) 1 PCI Express Gen2 x1 LP slot (x1 electrical/x1 mechanical)  NOTE: LP = low profile  NOTES: In the PCIe Gen3 slot (x16 electrical/x16 mechanical) slot, if it is not being used for a graphics card, only cards certified as After Market Options for this platform are supported.			
PCI Connectors (5.0V)	1 PCI LP slot			
Supported Drive Interfaces	SATA	Integrated (4) Serial ATA interfaces (2x 6Gb/s SATA in blue, 2x 3Gb/s SATA in black). One port can optionally be used for eSATA. <b>NOTE:</b> the Z220 SFF supports a maximum of two SATA/SSD drives only. RAID 0 and 1 supported. (Factory integrated RAID is Microsoft Windows only).		
	Serial Attached SCSI	None		
	Integrated RAID	<b>NOTE:</b> Requires identical hard drives (speeds, capacity, interface)		
	Integrated Graphics	Integrated Intel HD Graphics (on Pentium G640 processor); Integrated Intel HD Graphics 4000 (on Core i7-3xxx processors); Integrated Intel HD Graphics P4000 (on Intel Xeon E3-12x5v2 processors). Unified Memory Architecture (UMA)- A region of system memory is reserved and dedicated to the graphics display. Support for Microsoft DirectX® 10.1; OpenGL 3.0 on Intel HD Graphics P4000;		
		1 DisplayPort (DP 1.1) and 1 VGA graphics port integrated in motherboard; Supports dual displays across DP & VGA outputs		
	Network Controller	Integrated Gbit LAN MAC by Intel PHY Lewisville 82579LM; Management capabilities WOL, PXE 2.1 and AMT 8		
	External SATA (eSATA)	1 port eSATA capable with optional eSATA After-Market Option cable kit.		



	IDE connector	No			
	Floppy connector	No			
	Serial	1 rear port			
	2nd Serial	Yes- requires optional Serial Port Adapter Kit			
	Parallel	1 internal header (optional parallel port adapter required)			
	CD-ROM input (Audio)	No			
	AUX input (Audio)	No			
IEEE 1394 Connector(s)	Front	No			
ILLE 1334 Connector(3)	Rear	2 IEEE 1394b (requires optional PCIe 1394b card)			
	Internal	No			
USB Connector(s)	Front	4 USB 2.0			
O3D Connector (3)	Rear	4 USB 3.0, 2 USB 2.0			
	Internal				
UD Into grated Audio		4 USB 2.0			
HD Integrated Audio Flash ROM	Yes				
riasn kom CPU Fan Header	Not applicable passive CDU heatsink				
CPU Fan Header Chassis Fan Header	Not applicable - passive CPU heatsink				
	Yes				
Front Control Panel/Speaker Header	.!S				
CMOS Battery Holder - Lithium	es				
Integrated Trusted Platform Module	ntegrated TPM 1.2. he TPM module disabled where restricted by law, i.e. Russia.				
Power Supply Headers	Yes	5			
Power Switch, Power LED & Hard Drive LED Header	es				
Clear Password Jumper	Yes				
Keyboard/Mouse	USB or PS/2				
	240W, 90% efficiency				
Operating Voltage Range	90-264 VAC				
Rated Voltage Range	100-240 VAC				
Rated Line Frequency	50-60 Hz				
Operating Line Frequency Range	47-63 Hz				
Rated Input Current	4A @ 100-240V				
Heat Dissipation	Typical 546 btu/hr (138 kg-cal/hr)Maxi	mum 941 btu/hr (237 kg-cal/hr)			
Power Supply Fan	92x25 mm variable speed	<b>5</b>			
ENERGY STAR® qualified (Config Dependent)	Yes				
80 PLUS Compliant					



## **System Technical Specifications**

http://www.pluqloadsolutions.com/psu_reports/HP_DPS-
240TB%20A ECOS%202299 240W Report.pdf
http://www.pluqloadsolutions.com/psu_reports/HEWLETT-
PACKARD%20COMPANY_CFH240EWWB_ECOS%202304_240W_Report.pdf
Yes, Configuration dependent
, com garanon aspenant
Yes, with Wake-on-LAN disabled: <2W in S5- Power Off
<4W
No
Yes
Yes
165
v .
Yes
Declared Noise Emissions (Entry-level and High-end configurations)

### **System Configuration**

Example Configuration #1	To be advised later with the Intel Core i3 processor introduction.	
Example Configuration	Processor Info	1x Intel Xeon E3-1280v2 3.6 8MB 4C HT 69W GT0 CPU
	Memory Info	4GB (2x 2GB) 1600 MT/s DDR3 ECC
	Graphics Info	1x NVIDIA Quadro 600 1GB Graphics
	Disks/Optical/Floppy	1x SATA 1 TB 7.2k rpm/ 1 Optical
	PSU	240W 90%
	OS /BIOS	Win7 64/v 0.9

Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	44.	3 W	45.	1 W	44.	4 W
Windows Busy Typ (S0)		153	.7 W	150.8 W		154.2 W	
	Windows Busy Max (S0)	172.5 W		170	.3 W	176	.2 W
	Sleep (S3)	2.63 W	2.50W	2.65 W	2.53 W	2.64 W	2.50W
	Off (S5)	1.21 W	1.06 W	1.22 W	1.08 W	1.23 W	1.05 W
	Zero Power Mode (EuP)	0.2	6 W	0.3	3 W	0.2	6W



### **System Technical Specifications**

Heat Dissipation**		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	151.2 btu/hr		153.9 btu/hr		151.5 btu/hr	
	Windows Busy Typ (S0)	524.4 btu/hr		514.5 btu/hr		526.1 btu/hr	
	Windows Busy Max (S0)	588.6	btu/hr	581.1	btu/hr	601.2	btu/hr
	Sleep (S3)	8.97 btu/hr	8.53 btu/hr	9.04 btu/hr	8.63 btu/hr	9.00 btu/hr	8.53 btu/hr
	Off (S5)	4.12 btu/hr	3.62 btu/hr	4.16 btu/hr	3.68 btu/hr	4.20 btu/hr	3.58 btu/hr
	Zero Power Mode (EuP)	0.89 t	otu/hr	1.13 l	otu/hr	0.89 t	otu/hr

Example Configuration #3	Processor Info	1x Intel Xeon E3-1280v2 3.6 8MB 4C HT 69W GTO CPU
	Memory Info	32GB (4x 8GB) 1600 MT/s DDR3 ECC
	Graphics Info	1x NVIDIA Quadro 600 1GB Graphics
	Disks/Optical/Floppy	2x SATA 1 TB 7.2k rpm/ 1 Optical
	PSU	240W 90%
	OS /BIOS	Win7 64/v 0.9

Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	55.	0 W	56.	5 W	55.	3 W
	Windows Busy Typ (S0)	163	.5 W	165.6 W		165.2 W	
	Windows Busy Max (S0)	186	.6 W	195.	0 W	189	.5 W
	Sleep (S3)	3.44W	3.30 W	3.52 W	3.06 W	3.41 W	3.28 W
	Off (S5)	1.20 W	1.02 W	1.26 W	1.01 W	1.20 W	1.00 W
	Zero Power Mode (EuP)	0.2	7 W	0.34	4 W	0.2	5W
Heat Dissipation**		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	187.7	btu/hr	192.8	btu/hr	188.7	btu/hr
	Windows Busy Typ (S0)	557.9	btu/hr	565.0	btu/hr	563.7	btu/hr
	Windows Busy Max (S0)	657.2	btu/hr	665.3	btu/hr	646.6	btu/hr
	Sleep (S3)	11.74 btu/hr	11.26 btu/hr	12.01btu/hr	10.44 btu/hr	11.63 btu/hr	11.19 btu/hr
	Off (S5)	4.09 btu/hr	3.48 btu/hr	4.30 btu/hr	3.45 btu/hr	4.09 btu/hr	3.41 btu/hr
	Zero Power Mode (EuP)	0.92 t	otu/hr	1.16 b	tu/hr	0.85 t	otu/hr

#### **NOTES:**

<sup>\*\*</sup> Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour. This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (Entry-level and High-end configurations)				
System Configuration (Entry level)	Processor Info	Intel Core i7-3770 3.4 GHz		
	Memory Info	2 x 2GB DDR3 1600 MT/s		
	Graphics Info	Integrated Intel HD Graphics 4000		
	Disks/Optical	1x 250 GB 7200 RPM SATA HDD; SATA Blu-ray ODD		



<sup>\*</sup> Energy Star low energy mode

<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	<b>Desktop Sound Pressure</b> (LpAm, decibels)
	Idle	3.2	21
	Hard drive Operating (random reads)	3.4	23
	DVD-ROM Operating (sequential reads)	4.99	42

System Configuration	Processor Info	System Configuration (High-end)
(High-end)	Memory Info	4 x 4GB DDR3 1600 MT/s
	Graphics Info	NVIDIA Quadro 600
	Disks/Optical	2x 300GB 10K rpm SATA HDDs;
		SATA Blu-ray ODD

		Sound Power (LWAd, bels)	<b>Desktop Sound Pressure</b> (LpAm, decibels)
	Idle	3.4	24
	Hard drive Operating (random reads)	4.3	29
	DVD-ROM Operating (sequential reads)	5.0	42

Environmental Requirements	Temperature	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 10,000 feet (3,000 m) Non-operating: 30,000 feet (9,100 m)
	<b>Dynamic</b> (new)	Shock Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 20g, 422 cm/s  Vibration Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025 g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz
		<b>NOTES:</b> Values represent individual shock events and do not indicate repetitive shock events. Values do not indicate continuous vibration.
	Cooling	Above 5,000 ft (1524 m) altitude, maximum operating temperature is derated by 1.8° F (1° C) per 1,000 ft (305 m) elevation increase

Physical Security and Serviceability		
Access Panel	Tool-less Includes system board and memory information	
Expansion Cards	Tool-less	



Tool-less, except for the processor heatsink.
Yes, on tool-free internal chassis mechanisms
Yes
Tool-less
Screw-In
Yes
Yes
Yes
Restores the system to the factory shipped operating system. Orderable with the system and available from HP Support.
Yes, causes a fail-safe power off when held for 4 seconds
Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system
Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed.
Yes, locks rear IO cables to prevent cable theft
Yes, enables or disables serial, USB, audio, and network ports
Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Yes, prevents an unauthorized person from booting up the workstation
Yes, prevents an unauthorized person from changing the workstation configuration
Yes
Yes
A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
No
Yes, ACPI multi-function
Yes, blue (normal), red (fault)
Yes, green



Front ODD Activity LED	Yes			
Internal Speaker	Yes			
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.			
Cooling Solutions	Air cooled forced convection			
Power Supply Fans	2 mm x 92 mm x 25 mm 4-wire PWM (non-serviceable)			
CPU Heatsink Fan	ot applicable- CPU heatsink is passive.			
Chassis Fan	92 mm x 92mm x 25 mm 4-wire PWM			
Memory Heatsink Fan	No			
HP Advanced System Diagnostics Offline Edition	HP Advanced System Diagnostics enables you to perform hardware testing and view hardware and software configuration. HP Advanced System Diagnostics is provided on systems shipped with Windows and available as a download from HP Support.			
Access Panel Key Lock	No			
ACPI-Ready Hardware	<ul> <li>Advanced Configuration and Power Management Interface (ACPI).</li> <li>Allows the system to wake from a low power mode.</li> <li>Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system</li> </ul>			
Trusted Platform Module Chip with optional ProtectTools Software	Yes			
Integrated Chassis Handles	No			
Power Supply	Tool-less			
PCI Card Retention	Yes, rear (all), middle (none), front (none)			
Flash ROM	Yes			
Diagnostic Power Switch LED on board	Yes			
Clear Password Jumper	Yes			
Clear CMOS Button	Yes			
CMOS Battery Holder	Yes			
DIMM Connectors	Yes			
HP ProtectTools Security Manager	Yes - Not supported on Microsoft XP x64 or Linux			

BIOS		
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4	
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.	
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.	
BBS	BIOS Boot Specification v1.01.	
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.	
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.	



Review and customize system configuration settings controlled by the BiOS.  Recovers system BiOS in corrupted Flash ROM.  Resplicated Setup  Saves BiOS settings to USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  SMBIOS  System Management BiOS 2.7.1, for system management information.  System Management DiOS 2.7.1, for system management information.  Memory Change Alert  Thermal Alert  Monitors the temperature state within the chassis. Three modes:  • NORMAL - normal temperature ranges.  • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALERTED - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALIGNETIC - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALIGNETIC - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALIGNETIC - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALIGNETIC - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ALIGNETIC - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware consumption based on the dynamic workload.  Assert of the computer of the system power consumption based on the dynamic workload.  ASE 2.0 Compliant  Instantly Available DC  Cisuspend to RAM - ACPI  Septem damagement for file of the system.  ALIGNETIC - excessiv				
Recovers system BIOS in corrupted Flash ROM.  Resplicated Setup  Saves BIOS settings to USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  SMBIOS  System Management BIOS 2.7.1, for system management information.  Disables the ability to boot from removable media on supported devices.  Memory Change Alert  Thermal Alert  Monitors the temperature console if memory is removed or changed.  NORMAL - normal temperature ranges.  NORMAL - normal temperature ranges.  NORMAL - normal temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash  ACPI (Advanced  Configuration and Power  Management Interface)  Allows the system to enter and resume from low power modes (sleep states).  Enables an operating system to control system power consumption based on the dynamic workload.  Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Ownership Tag  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  System administrators can power on, restart, and power off a client computer from a remote location.  Shitudown  No.  Allows for very low power consumption with quick resume time.  Suspend to RAM - ACPI sleep state S3)  Remote System  Installation via F12 (PXE)  Allows a new or existing system to boot over the network and download software, including the power state S3)  Remote System  Provides recovery of the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management S	BIOS Power On	Users can define a specific date and time for the system to power on.		
Flash Recovery with Wideo  Replicated Setup  Saves BIOS settings to USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  SMBIOS  System Management BIOS 2.7.1, for system management information.  Bioables the ability to boot from removable media on supported devices.  Memory Change Alert  Thermal Alert  Monitors the temperature console if memory is removed or changed.  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges.  NORMAL - normal temperature ranges.  NORMAL - normal temperature sare detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash  ACPI (Advanced  Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states).  Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power of powered-off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  System administrators can power on, restart, and power off a client computer from a remote location.  Shatantly Awailable PC  Suspend to RAM - ACPI  Suspend to RAM - ACPI  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  PROM revision levels  ROM revision levels  ROM revision levels  ROM revision levels  ROM revision levels  Romagement SW to read revision level in Computer Configuration Utility	ROM Based Computer Setup Utility (F10)	, , ,		
these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  System Management BIOS 2.7.1, for system management information.  Biost Control  Disables the ability to boot from removable media on supported devices.  Memory Change Alert  Thermal Alert  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges.  NORMAL - normal temperature ranges.  NORMAL - normal temperature sare detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - excessive temperatures are neconstread, Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash  ACPI (Advanced  Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states).  Enables an operating system to control system power consumption based on the dynamic workload.  Ades it possible to place individual cards and peripherals in a low-power or powered-off state withou affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  Remote Wakeup/Remote  Shutdown  No.  Instantly Available PC  Allows for very low power consumption with quick resume time.  Suspont to RAM – ACPI sleep state 53)  Remote System  Allows for very low power consumption with quick resume time.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows an anagement SW to read revision level of the system board.  Revision level is digitally encoded into the HW and cannot be modified.  Sessers system health at boot time with selectable levels of testing.  Assesses system health at boot time with selectable levels of	System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.		
Disables the ability to boot from removable media on supported devices.  Memory Change Alert  Alerts management console if memory is removed or changed.  Monitors the temperature state within the chassis. Three modes:  • NORMAL - normal temperature ranges. • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash ACPI (Advanced Configuration and Power Management Interface) Affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Ownership Tag Remote Wakeup/Remote Shutdown ASF 2.0 Complian No.  Instantly Available PC (Suspend to RAM - ACPI skeep steem shardware) Allows for very low power consumption with quick resume time.  Susports ACPI 2.1 (Remote Boot from Server)  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows a new or existing system to boot over the network and download software, including the operating system.  Allows an enw or existing system to boot over the network and download software, including the operating system.  Allows an anewore resisting system to boot over the network and download software, including the operating system.  Allows an anagement SW to read revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBiOS) so that management SW applications can use and report this information.  Allows management SW to read revision level of the system board.  Revision level is digitally encoded into the HW and cannot be modified.  Assesses system health at boot time with selectable levels of testing.  Common BiOS images supports System Configur	Replicated Setup	these settings on machines being deployed without entering Computer Configuration Utility (F10		
Memory Change Alert Thermal Alert  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash ACPI (Advanced Configuration and Power Management Interface) Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state withou affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems. Supports ACPI 2.0 for full compatibility with 64-bit operating system. System administrators can power on, restart, and power off a client computer from a remote location.  No. Instantly Available PC (Suspend to RAM - ACPI sleep state S3) Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  Allows an anagement SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.  Scart-up Diagnostics (Power-on Self-Test) Auto Setup when new hardware installed Keyboard-less Operation The system can be booted without a keyboard.  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	SMBIOS	System Management BIOS 2.7.1, for system management information.		
Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges. ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash ACPI (Advanced Configuration and Power Management Interface) Management Interface)  Makes it possible to place individual cards and peripherals in a low-power on powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Downership Tag A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. System administrators can power on, restart, and power off a client computer from a remote location.  SAF 2.0 Compliant Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE C31) (Remote Boot from Server)  ROM revision levels Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision Level Revision levels Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test) Auto Setup when new hardware installed Keyboard-less Operation The system can be booted without a keyboard.  Localized ROM Setup  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	Boot Control	Disables the ability to boot from removable media on supported devices.		
NORMAL - normal temperature ranges.     ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.     SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash ACPI (Advanced Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload.  Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Domership Tag A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  System administrators can power on, restart, and power off a client computer from a remote location.  Shutdown ASF 2.0 Compliant No.  Instantly Available PC (Suspend to RAM - ACP) sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision  Level  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision  Level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics  (Power-on Self-Test)  Auto Setup when new hardware installed  Keyboard-less Operation  The system can be booted without a keyboard.  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 langua	Memory Change Alert	Alerts management console if memory is removed or changed.		
Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state withou affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Ownership Tag A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  System administrators can power on, restart, and power off a client computer from a remote location.  Shutdown  No. Allows for very low power consumption with quick resume time.  Seleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision  Level  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Keyboard-less Operation  The system can be booted without a keyboard.  Localized ROM Setup  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	Thermal Alert	<ul> <li>NORMAL - normal temperature ranges.</li> <li>ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.</li> <li>SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the</li> </ul>		
Configuration and Power Management Interface)  Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state withou affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  System administrators can power on, restart, and power off a client computer from a remote location.  No.  Allows for very low power consumption with quick resume time.  Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Keyboard-less Operation  Localized ROM Setup  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.		
A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.  System administrators can power on, restart, and power off a client computer from a remote location.  No.  ASF 2.0 Compliant  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Keyboard-less Operation  Localized ROM Setup  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	ACPI (Advanced Configuration and Power Management Interface)	Allows the system to enter and resume from low power modes (sleep states).  Enables an operating system to control system power consumption based on the dynamic workload.  Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.		
System administrators can power on, restart, and power off a client computer from a remote location.  No.  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  Allows management SW to read revision level of the system board.  Revision level is digitally encoded into the HW and cannot be modified.  Assesses system health at boot time with selectable levels of testing.  System when new hardware installed  Keyboard-less Operation  Localized ROM Setup  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	Ownership Tag			
Allows for very low power consumption with quick resume time.  (Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision  Revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Keyboard-less Operation  Localized ROM Setup  Allows for very low power consumption with quick resume time.  Allows a new or existing system to boot over the network and download software, including the operation system.  Allows a new or existing system to boot over the network and download software, including the operation system.  Allows a new or existing system to boot over the network and download software, including the operation system.  Allows a new or existing system to boot over the network and download software, including the operation is available to boot in available to computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  Allows management SW to read revision level of the system board.  Assesses system health at boot time with selectable levels of testing.  System automatically detects addition of new hardware.  The system can be booted without a keyboard.  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.				
(Suspend to RAM - ACPI sleep state 53)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Keyboard-less Operation  The system can be booted without a keyboard.  Localized ROM Setup  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	ASF 2.0 Compliant	No.		
operating system.  2.1) (Remote Boot from Server)  ROM revision levels Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision Revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Keyboard-less Operation  The system can be booted without a keyboard.  Localized ROM Setup  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.		
available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Assesses system health at boot time with selectable levels of testing.  System automatically detects addition of new hardware.  System automatically detects addition of new hardware.  The system can be booted without a keyboard.  Localized ROM Setup  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)			
Revision level is digitally encoded into the HW and cannot be modified.  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Keyboard-less Operation  Localized ROM Setup  Revision level is digitally encoded into the HW and cannot be modified.  System automatically detects addition of new hardware.  System automatically detects addition of new hardware.  The system can be booted without a keyboard.  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	ROM revision levels	available through an industry standard interface (SMBIOS) so that management SW applications ca		
Auto Setup when new hardware installed  Keyboard-less Operation Localized ROM Setup  Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	System board revision level			
hardware installed  Keyboard-less Operation The system can be booted without a keyboard.  Localized ROM Setup Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.		
Localized ROM Setup Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.	Auto Setup when new hardware installed	System automatically detects addition of new hardware.		
local keyboard mappings.	Keyboard-less Operation			
Asset Tag The user or IT administrator to set a unique tag string in non-volatile memory.	Localized ROM Setup			
	Asset Tag	The user or IT administrator to set a unique tag string in non-volatile memory.		



### **System Technical Specifications**

Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.		
Adaptive Cooling	ontrol parameters are set according to detected hardware configuration for optimal acoustics.		
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.		
Intel® Active Management Technology (AMT)	AMT 8.0; Allows workstation status to be monitored on a remote console		
Digitally and Cryptographically Signed BIOS	Helps to prevent the installation of unauthorized versions of a BIOS (a rogue BIOS) from a virus, malware, or other code that could lead to compromised system security, data access, physical service, or even system board replacement.		
Master Boot Record Protection	A feature in the HP BIOS that prevents changes and/or infections to the Master Boot Record. Useful in protecting from viruses.		
Boot Block Emergency Recovery Mode (BIOS Recovery)	The HP BIOS offers a write-protected boot block ROM that provides recovery from a failed flashing of the computer BIOS. This special recovery mode prevents the system from becoming unusable or "bricked" when a BIOS update is interrupted.		
Industry Standard Specification Support			
UEFI Specification Revision	UEFI 2.3.1		
Industry Standard	Revision Supported by the BIOS		
ACPI	Advanced Configuration and Power Management Interface, Version 2.0c		
ASF	Alert Standard Format Specification, Version 2.0		
ATA (IDE)	T Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b		
CD Boot	El Torito" Bootable CD-ROM Format Specification Version 1.0		
EDD	- Enhanced Disk Drive Specification Version 1.1 - BIOS Enhanced Disk Drive Specification Version 3.0		
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0		
PCI	PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7		
PCI Express	PCI Express Base Specification, Revision 2.0; PCI Express Base Specification, Revision 3.0.		
PMM	POST Memory Manager Specification, Version 1.01		
SATA	- Serial ATA Specification, Revision 1.0a - Serial ATA II: Extensions to Serial ATA 1.0, Revision 1.0a - Serial ATA II Cables and Connectors Volume 2 Gold - SATA-IO SATA Revision 3.0 Specification		
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B		
ТРМ	Trusted Computing Group TPM Specification Version 1.2		
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.0 Specification		

Social	and Env	rironmental	Responsibility

<b>Eco-Label Certifications</b>
& Declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- ENERGY STAR® (energy-saving features available on selected configurations -Windows only)
- US Federal Energy Management Program (FEMP)



System reclinical Sp				
	<ul> <li>China Energy Conservation Program (CECP)</li> <li>IT ECO declaration</li> </ul>			
Batteries	The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal			
	Batteries used in the product do not contain:			
	<ul> <li>Mercury greater than 5ppm by weight</li> <li>Cadmium greater than 10ppm by weight</li> <li>Lead greater than 40 ppm by weight.</li> </ul>			
Restricted Material Usago	This product meets the material restrictions specified in HP's General Specification for the the Environment: <a href="http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pdf">http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/qse.pdf</a>			
	Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.			
	This product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: Creative Recon3D PCIe Audio Card and Broadcom 5761 Gigabit PCIe NIC are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.			
Low Halogen Statement	This product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: Creative Recon3D PCIe Audio Card and Broadcom 5761 Gigabit PCIe NIC are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.			
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/recycle">http://www.hp.com/recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.			
Hewlett-Packard Corporate Environmental	For more information about HP's commitment to the environment:			
Information	Global Citizenship Report <a href="http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html">http://www.hp.com/hpinfo/qlobalcitizenship/qcreport/index.html</a>			
Additional Information	<ul> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.</li> <li>Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and</li> </ul>			
	<ul><li>ISO1043.</li><li>This product is &gt;90% recycle-able when properly disposed of at end of life.</li></ul>			
	EPEAT Gold registered in the U.S. EPEAT registration varies by country. See <a href="https://www.epeat.net">www.epeat.net</a> for registration status by country			
Packaging	HP Workstation product packaging meets the HP General Specification for the Environment at <a href="http://www.hp.com/hpinfo/qlobalcitizenship/society/qen_specifications.html">http://www.hp.com/hpinfo/qlobalcitizenship/society/qen_specifications.html</a>			
	Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment			
	<ul> <li>Does not contain ozone-depleting substances (ODS)</li> <li>Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed</li> </ul>			
	Maximizes the use of post-consumer recycled content materials in packaging materials			



	<ul> <li>All packaging material is recyclable</li> <li>All packaging material is designed for ease of disassembly</li> <li>Reduced size and weight of packages to improve transportation fuel efficiency</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting</li> </ul>
Packaging Materials	
Internal	Cushions and plastic bags made of low density polyethylene (LDPE).
External	Outer carton, accessories carton, and insert made of corrugated paper board.

Manageability			
	An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 8.0 includes the following advanced management functions:  Power Management (on, off, reset) Hardware Inventory (includes BIOS and firmware revisions Hardware Alerting Agent Presence System Defense Filters SOL/IDER Cisco NAC/SDN Support ME Wake-on-LAN DASH 1.1 compliance IPv6 Support Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection Remote Scheduled Maintenance - pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc. to connecting to their IT console or Service Provider when it's convenient Remote Alerts - automatically alert IT or service provider if issues arise Access Monitor - Provides oversight into Intel® AMT actions to support security requirements PC Alarm Clock Microsoft NAP Support		
	<ul> <li>Host Base set-up and configuration</li> <li>Management Engine (ME) firmware roll back</li> <li>Wireless AMT functionality on Desktop (WoDT)</li> <li>Enhanced KVM resolution</li> </ul>		
Intel® vPro™ Technology	The HP Z220 workstations support Intel vPro technology when purchased with a vPro technology capable CPU: Intel® Xeon® processor E3-1200v2 family or 3rd Generation Intel Core i5/i7 processors with Intel VT and Intel TXT technology		
Remote Manageability Software Solutions	Visit: http://www.hp.com/go/easydeploy		
System Software Manager	Visit: http://www.hp.com/go/ssm		
Service, Support, and Warranty	<ul> <li>Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.</li> <li>PCNs provide advance notification of hardware and software changes to be implemented in</li> </ul>		



## **System Technical Specifications**

the factory providing time to plan for transition.

• Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.



### **Stable & Consistent Offerings**

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost, no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering
	A8Y07AV	Intel® Xeon® processor E3-1280v2, 3.6/4.0GHz, 69W, 8 MB cache, 1600 MT/s memory, Quad-Core, HT, featuring Intel® vPro Technology
	A8Y04AV	Intel® Xeon® processor E3-1240v2, 3.4/3.8GHz, 69W, 8 MB cache, 1600 MT/s memory, Quad-Core, HT, featuring Intel® vPro Technology
	A8Y02AV	Intel <sup>®</sup> Xeon <sup>®</sup> processor E3-1225v2, 3.2/3.6GHz, 77W, 8 MB cache, 1600 MT/s memory, Quad-Core, no HT, Intel <sup>®</sup> HD Graphics P4000, featuring Intel <sup>®</sup> vPro Technology
Hard Drives	Product #	Offering
	A8X40AV	1TB 7200 RPM SATA 6G 1st HDD
	A8X52AV	1TB 7200 RPM SATA 6G 2nd HDD
	A8X39AV	500GB 7200 RPM SATA 6G 1st HDD
	A8X51AV	500GB 7200 RPM SATA 6G 2nd HDD
Graphics	Product #	Offering
	A7U41AV	NVIDIA NVS 310 512MB Graphics
	A7U42AV	NVIDIA NVS 310 512MB 2nd Graphics
Memory	Product #	Offering
	A8Y23AV	16GB DDR3-1600 ECC (4x4GB) RAM
	B4Y02AV	12GB DDR3-1600 ECC (2x4GB+2x2GB) RAM
	A8Y22AV	8GB DDR3-1600 ECC (2x4GB) RAM
	A8Y21AV	8GB DDR3-1600 ECC (4x2GB) RAM
	A8Y20AV	4GB DDR3-1600 ECC (2x2GB) RAM
	A8Y19AV	2GB DDR3-1600 ECC (1x2GB) RAM
Optical and Removable	Product #	Offering
Storage	A8X92AV	16X SuperMulti DVDRW SATA 1st ODD
Operating Systems	Product #	Offering
	A3J50AV	Genuine Windows® 7 Professional 64-bit



### **Technical Specifications - Processors**

#### **Processors**

Intel® Xeon® processor E3-1280v2, Quad-Core, 8 MB cache, 3.6 GHz, up to 4.0 GHz with Intel Turbo Boost Technology

Intel® Xeon® processor E3-1270v2, Quad-Core, 8 MB cache, 3.5 GHz, up to 3.9 GHz with Intel Turbo Boost Technology

Intel® Xeon® processor E3-1245v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology

Intel® Xeon® processor E3-1240v2, Quad-Core, 8 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology

Intel® Xeon® processor E3-1230v2, Quad-Core, 8 MB cache, 3.3 GHz, up to 3.7 GHz with Intel Turbo Boost Technology

Intel® Xeon® processor E3-1225v2, Quad-Core, 8 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology

Intel® Core™ i7-3770 processor, Quad-Core, 8 MB cache, 3.4GHz, up to 3.9 GHz with Intel Turbo Boost Technology

Intel® Core™ i5-3470 processor, Quad-Core, 6 MB cache, 3.2 GHz, up to 3.6 GHz with Intel Turbo Boost Technology

Intel® Core™ i5-3570 processor, Quad-Core, 6 MB cache, 3.4 GHz, up to 3.8 GHz with Intel Turbo Boost Technology

Intel® Core™ i3-3240 processor, Dual-Core, 3 MB cache, 3.4 GHz

Intel® Core™ i3-3220 processor, Dual-Core, 3 MB cache, 3.3 GHz

Intel® Pentium® G2020 processor, Dual-Core, 3 MB cache, 2.9 GHz



9.5 ms

## QuickSpecs

### Technical Specifications - Hard Drives

SATA (Serial ATA) Hard **Drives for HP** Workstations

300GB SATA 10K rpm SFF Capacity in 3.5" Frame HDD

300,069,052,416 bytes Height 1 in; 2.54 cm

Width **Media Diameter** 2.5 in: 6.36 cm **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled

Synchronous Transfer

Rate (Maximum)

Up to 300 MB/s

**Full Stroke** 

Cache 16 MB

**Seek Time** (typical reads, **Single Track** 0.7 ms (maximum) includes controller Average 4.4 ms overhead, including

settling)

**Rotational Speed** 10,000 rpm **Logical Blocks** 586,072,368

**Operating Temperature** 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 1 Terabyte (1000 GB) Height 1 in; 2.54 cm

**Media Diameter** Width 3.5 in; 8.9 cm **Physical Size** 4 in: 10.17 cm

Up to 600 MB/s

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

**Buffer 32MB Seek Time** (typical reads, **Single Track** 

2 ms includes controller Average 11 ms overhead, including **Full Stroke** 21 ms

settling)

**Rotational Speed** 7,200 rpm **Logical Blocks** 1,953,525,168

**Operating Temperature** 41° to 131° F (5° to 55° C)

500GB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 500GB 1 in: 2.54 cm Height

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

**Synchronous Transfer** 

Rate (Maximum)

Up to 600MB/s

**Buffer 16MB** 

Seek Time (typical reads, **Single Track** 2 ms includes controller **Average** 11 ms overhead, including **Full Stroke** 21 ms

settling)

Rotational Speed 7,200 rpm



### **Technical Specifications - Hard Drives**

**Logical Blocks** 976,773,168

**Operating Temperature** 41° to 131° F (5° to 55° C)

250GB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 250 GB Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Up to 600MB/s

Serial ATA (6.0Gb/s), NCQ enabled Interface

**Synchronous Transfer** 

Rate (Maximum)

**Buffer** 8 MB

**Seek Time** (typical reads, **Single Track** 2 ms includes controller **Average** 11 ms overhead, including **Full Stroke** 21 ms settling)

**Rotational Speed** 7,200 rpm **Logical Blocks** 488,397,168

**Operating Temperature** 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 2TB

Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm

**Physical Size** 4 in; 10.17 cm

**Interface** Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s

**Buffer** 64MB

**Seek Time** (typical reads, **Single Track** 1.0 ms includes controller **Average** 11 ms overhead, including **Full Stroke** 18 ms

settling)

**Rotational Speed** 7,200 rpm **Logical Blocks** 3,907,029,168

**Operating Temperature** 41° to 131° F (5° to 55° C)

250GB SATA 10K rpm SFF Capacity

HDD

250GB

0.6 in: 1.53 cm Height

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s) **Synchronous Transfer** Up to 600MB/s

Rate (Maximum)

**Buffer 64MB** Cache Adaptive

**Seek Time** (typical reads. **Single Track** 1.2ms (typical) includes controller 3.6ms

**Average** 

### **Technical Specifications - Hard Drives**

	overhead, including settling)	Full Stroke	9.0ms (typical)
	Rotational Speed	10K rpm	
	Operating Temperature	41° to 131° F (5° to 55° (	<b>C)</b>
500GB SATA 10K rpm SFF	Capacity	500GB	
HDD	Height	0.6 in; 1.53 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
	Interface	Serial ATA (6Gb/s)	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
	Buffer	64MB	
	Cache	Adaptive	
	<b>Seek Time</b> (typical reads,	Single Track	1.2ms (typical)
	includes controller	Average	3.6ms
	overhead, including settling)	Full Stroke	9.0ms (typical)
	Rotational Speed	10K rpm	
	Operating Temperature	41° to 131° F (5° to 55° (	<b>C)</b>
1TB SATA 10K rpm SFF	Capacity	1TB	
HDD	Height	0.6 in; 1.53 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
	Interface	Serial ATA (6Gb/s)	
	Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
	Buffer	64MB	
	Cache	Adaptive	
	<b>Seek Time</b> (typical reads,	Single Track	1.2ms (typical)
	includes controller overhead, including	Average	3.6ms
	settling)	Full Stroke	9.0ms (typical)
	Rotational Speed	10K rpm	
	Operating Temperature	41° to 131° F (5° to 55° (	C)
500GB SATA 7.2K SED SFF	Capacity	500GB	
HDD	Height	0.275 in; 0.7 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
		-	
	Interface	Serial ATA (6Gb/s)	
	Interface Synchronous Transfer Rate (Maximum)	-	
	Synchronous Transfer	Serial ATA (6Gb/s)	

### **Technical Specifications - Hard Drives**

includes controller Average 4.2ms
overhead, including settling)

Rotational Speed 7,200 rpm

**Operating Temperature** 32° to 140° F (0° to 60° C)

HP Solid State Drives (SSDs) for Workstations

HP 128GB SATA 6Gb/s SSD Capacity 128GB
Height 0.28 in; 0.7 cm

Width Physical Size 2.5 in; 6.36 cm

**Interface** SATA 6Gb/s

Synchronous Transfer Up to 500MB/s (Sequential Read)
Rate (Maximum)

**Operating Temperature** 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s SSD Capacity256GBHeight0.28 in; 0.7 cmInterfaceSATA 6Gb/s

Synchronous Transfer Rate (Maximum)

Up to 500MB/s (Sequential Read)

**Operating Temperature** 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s SED SSD 
 Capacity
 256GB

 Height
 0.28 in; 0.7 cm

Width Physical Size 2.5 in; 6.36 cm

Interface 6Gb/s SATA

**Synchronous Transfer Rate** (Maximum)

Up to 500MB/s (Sequential Read)

**Operating Temperature** 32° to 158° F (0° to 70° C)

HP 512GB SATA 6Gb/s SSD 
 Capacity
 512GB

 Height
 0.28 in; 0.7 cm

Width Physical Size 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

**Operating Temperature** 32° to 158° F (0° to 70° C)

### Technical Specifications - Graphics

NVIDIA NVS 300 512MB Graphics

**Form Factor** 2.7 inches (H) x 5.7 inches (L), Half-Height

Graphics Controller NVIDIA NVS 300 Graphics Board Bus Type PCI Express x16, Generation 2.0

**Memory** 512 MB GDDR3 SDRAM unified graphics memory

**Connectors** DMS-59

Includes DMS-59 to Dual DVI-I adapter

DMS-59 to Dual DisplayPort adapter and DMS-59 to Dual VGA adapter

available as an option

DMS-59 to Dual DisplayPort adapter required for HP ZR30w Display

**Maximum Resolution** DVI: two digital displays up to 1920 x 1200

DisplayPort: two digital displays up to 2560 x 1600

VGA: two analog displays up to 1920 x 1080

Image Quality Features

**Display Output** This card support up to two displays:

 Drives DVI enabled digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking

 Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking (through optional DMS-59 to DisplayPort adapter)

 Drives VGA enabled analog displays at resolutions up to 1920 x 1080 (through optional DMS-59 to VGA adapter)

**Supported Graphics APIs** OGL 3.3

DirectX 10.1

Available Graphics Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: <a href="mailto:tp://download.nvidia.com/novell">tp://download.nvidia.com/novell</a> or <a href="http://www.nvidia.com/novell">http://www.nvidia.com/novell</a> or <a href="http://www

**Power Consumption** <18 Watts

NVIDIA NVS 310 512MB Graphics **Form Factor** Low Profile:

2.713 inches in height × 6.150 inches in length

Weight: ~142 grams

**Graphics Controller** NVIDIA NVS 310

GPU: GF119-825

**Bus Type** PCI Express x16, 2.0 compliant

Memory Size: 512MB DDR3 Clock: 875Mhz

Memory Bandwidth: 14GB/s

**Connectors** 2 x DisplayPort

**Maximum Resolution** Up to 2560 x 1600 (digital display) per display.

### Technical Specifications - Graphics

#### **Image Quality Features**

The following video formats are supported:

- MPEG4 Part 2 Advanced Simple Profile
- H.264 SVC codec support
- Support for 3D Blu Ray
- VC1
- DivX version 3.11 and later
- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

#### **Display Output**

Up to 2 displays in the following configurations:

### DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card
- Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort 1.2 multi stream topology technology.

#### **DVI-D** output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors
- Drives two digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

### **HDMI** output:

NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

### VGA display output:

Shader Model 5.0

Drives two analog display at resolutions up to 1920 x 1200 at 60 Hz using DisplayPort to VGA cable adaptors

**Shading Architecture** Supported Graphics APIs DX11, OpenGL 4.1 **Available Graphics** 

**Drivers** 

Windows 8

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)



### **Technical Specifications - Graphics**

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

Note

19.5 Watts

The thermal solution used on this card is an active fan heatsink.
 Factory configured NVS 310 graphics card have no cable adpaters

included. Adapters must be ordered separately.

3. Option kit NVS 310 includes 2 DP to DVI-D cable adapters.

### NVIDIA NVS 510 2GB Graphics

Form Factor

Low Profile, 2.713 inches × 6.3 inches, single slot

**Graphics Controller** NVS 510 GPU

Core Clock: 797 Mhz Memory Clock: 891 Mhz CUDA Cores: 192

**Bus Type** PCI Express x16, Generation 2.0

Memory 2GB DDR3

**Connectors** Four mini-DisplayPort.

Four mini-DisplayPort to DisplayPort adapters included.

(DisplayPort to DVI-D, DisplayPort to VGA, DisplayPort to HDMI, and DisplayPort to Dual-Link DVI adapters available as separate accessories)

**Maximum Resolution** 

Mini-DisplayPort connectors support ultra-high-resolution panels (up to

3840 x 2160 @ 60Hz)

**NOTE:** This card supports up to four displays. For Windows XP, only 2 active displays are supported.

**Image Quality Features** 

10-bit internal display processing, including hardware support for 10-bit

scan-out

**Display Output** 

DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2

(HBR2) support.

Digital Display Support

### 1. DisplayPort Output

- Drives four DisplayPort enabled digital display at resolutions up to 3840 × 2160 at 60 Hz with reduced blanking, when connected natively using the 4 DisplayPort connectors on the NVS 510 graphics card.

- DisplayPort Multi-Stream Topology (MST) Technology: Supports various combinations of display resolutions and number of displays when using DisplayPort multi stream topology technology - up to a maximum of 4 monitors at a resolution of 1920 × 1200 at 60 Hz with reduced blanking.

#### 2. DVI-D Output

- Drives four digital displays at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors.
 - Drives four digital displays at resolutions up to 2560× 1600 at 60 Hz with

reduced blanking using DisplayPort to DVI-D dual-link cable adaptors.

### Technical Specifications - Graphics

3. HDMI Output

- The NVS 510 graphics board is capable of driving four high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors.

**Analog Display Support** 

1. VGA display output

- Drives four analog displays at resolutions up to 1920 × 1200 at 60 Hz

using DisplayPort to VGA cable adaptors.

Supported Graphics APIs Full Microsoft Direct X 11, Shader Model 5.0 support

Full OpenGL 4.3 support

**Available Graphics** 

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**Power Consumption** 

Note

33.4 Watts

Heatsink cooler design is active.

PCI Express® x16. Generation 2.1

### AMD FirePro V3900 1GB **Graphics**

**Form Factor** 

**Bus Type** 

Full height, half length (full-height bracket included)

**Graphics Controller** AMD FirePro™ V3900 professional graphics

Memory 1GB DDR3 memory

**Maximum Resolution** 2560x1600 per display (5120x1600 max. horizontal resolution)

**Display Output** 1 DisplayPort® 1.2

1 Dual-link DVI

**Shading Architecture** Shader Model 5.0

Supported Graphics APIs OpenCL™ 1.1, DirectX® 11 and OpenGL 4.2

**Available Graphics** 

**Drivers** 

Genuine Windows® 7 Professional (64-bit and 32-bit) Genuine Windows Vista® Business (64-bit and 32-bit) Microsoft® Windows XP® Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

**Power Consumption** 

Note

<50W

AMD Evefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7. Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s)

may be required. See www.amd.com/firepro for details.

### Technical Specifications - Graphics

NVIDIA Quadro K600 1GB Form Factor

**Graphics** 

2.731" H x 6.3" L

Single Slot, Low Profile

Full Height Profile bracket installed Low Profile bracket included

**Graphics Controller** NVIDIA Quadro K600 Graphics Card

Kepler GK107 GPU 192 CUDA cores Max Power: 41 Watts

Bus Type PCI Express 2.0 x16

Memory 1 GB GDDR3, 891 Mhz
128-bit memory I/O path

29 GB/s memory bandwidth

**Connectors** 1 DL-DVI(I) output, 1 DisplayPort output

CTO: No video cable adapter included

AMO: One DP-to-DVI adapter included with card

Additional DVI-to-VGA, DisplayPort-to-VGA or DisplayPort-to-DVI adapters

are available as accessories

**Maximum Resolution** DisplayPort:

- up to 3840 x 2160 x 30 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60Hz

**Image Quality Features** 

10-bit internal display processing pipeline

10-bit scan-out support

**Display Output** VGA:

- requires use of DVI-to-VGA and/or DP-to-VGA video cable adapters

- 400 Mhz integrated RAMDAC

- Max resolution: 2048 x 1536 x 32 bpp @ 85 Hz

DL-DVI(I):

- Max resolution: 2560 x 1600 x 32 bpp @ 60 Hz

SL-DVI(I):

- Max resolution: 1920 x 1200 x 32 bpp @ 60 Hz

DisplayPort:

- Supports HBR2 and MST

- Max resolution: 3840 x 2160 x 30 bpp @ 60 Hz (only one monitor can be connected to the Quadro K600 DisplayPort connector at this resolution)

- Max number of daisy-chained monitors: 2 Full Microsoft DirectX 11 Shader Model 5.0

Shading Architecture

Supported Graphics APIs OpenGL 4.3

DirectX 11

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

**Available Graphics** 

**Drivers** 

Windows 8 Pro 64-bit Windows 8 (China) 64-bit

Genuine Windows 7 Professional (64-bit and 32-bit)

#### **Technical Specifications - Graphics**

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: <a href="mailto:tp://download.nvidia.com/novell">tp://download.nvidia.com/novell</a> or <a href="http://www.nvidia.com/novell">http://www.nvidia.com/novell</a> or <a href="http://www.nvidia.com/novell">http://www.nvidia.com/novell</a> or

**Notes** 

- Quadro K600 offered as CTO does not include a video cable adapter. Video cable adapters must be ordered separately.
- 2. Quadro K600 offered as AMO includes one DP-to-DVI video cable adapter. Additional cables must be ordered separately.
- 3. Quadro K600 is Windows 8 Compliant.
- 4. A total maximum of 2 active monitors are supported across all display output types.

### NVIDIA Quadro 410 512MB Graphics

Form Factor Low Profile:

2.713 inches × 5.7 inches, single slot

Graphics Controller NVIDIA Quadro 410

GPU: GK107

**Bus Type** PCI Express x16, 3.0 compliant

**Memory** Size: 512MB DDR3

Clock: 900MHz

Memory Bandwidth: 14GB/s

Connectors One dual-link DVI-I connector

One DisplayPort connector

**Maximum Resolution** VGA (through DVI to VGA cable):

2048 × 1536 × 32 bpp at 85 Hz

**Dual-link DVI** 

2560 × 1600 × 32 bpp at 60 Hz (reduced blanking)

Single-link DVI

1920 × 1200 × 32 bpp at 60 Hz (reduced blanking)

DisplayPort 1.2

3840 × 2160 × 36 bpp at 60 Hz

RAMDAC 400 MHz integrated RAMDAC

**Display Output** Maximum number of displays supported: 2

Shading Architecture Shader Model 5.0
Supported Graphics APIs DX11, OpenGL 4.2
Available Graphics Windows 8



### **Technical Specifications - Graphics**

**Drivers** Genuine Windows 7 Professional (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: <a href="mailto:tp://download.nvidia.com/novell">tp://download.nvidia.com/novell</a> or <a href="http://www.nvidia.com/novell">http://www.nvidia.com/novell</a> or <a href="http://www.nvidia.com/novell">http://www.nvidia.com/novell</a> or

Notes 1. Factory configured Quadro 410 does not include any video adapters.

Adapters must be ordered separately.

2. Option kit Quadro 410 includes one DP to DVI-D adapter



### Technical Specifications - Optical and Removable Storage

**HP DVD-ROM Drive** Description 5.25-inch, half-height, tray-load

**Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

**Dimensions** (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

**Disc Capacity DVD-ROM** Single layer: Up to 4.7 GB Double layer: Up to

8.5 GB

**Access Times DVD-ROM Single Layer** < 140 ms (typical)

> **CD-ROM Mode 1** < 125 ms (typical) **Full Stroke DVD** < 250 ms (seek) **Full Stroke CD** < 210 ms (seek)

Power SATA DC power receptacle Source

> **DC Power Requirements**  $5 \text{ VDC} \pm 5\%-100 \text{ mV ripple p-p}$ 12 VDC ± 5%-200 mV ripple p-p

**DC Current** 5 VDC - <1000 mA typical, < 1600 mA maximum

12 VDC - < 600 mA typical, < 1400 mA

maximum

**Operating Environmental Temperature** 

(all conditions noncondensing)

41° to 122° F (5° to 50° C) **Relative Humidity** 10% to 90%

**Maximum Wet Bulb Temperature** 

86° F (30° C)

**Operating Systems** 

Supported

Windows 7 Professional 32-bit and 64-bit. Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP Professional or

Windows XP Home 32\*.

Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, 6

Desktop/Workstation,

Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

**HP DVD+/-RW Drive** 

Description

5.25-inch, half-height, tray-load

**Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

**Dimensions** (WxHxD)

15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

**Disc Formats DVD-RAM** 

> DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R

CD-RW

**Disc Capacity DVD-ROM** 8.5 GB DL or 4.7 GB standard

> **Full Stroke DVD** < 250 ms (seek) Full Stroke CD < 210 ms (seek)



### Technical Specifications - Optical and Removable Storage

Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 40X CD-RW Up to 32X		
	DVD ROM Read	DVD-RAM	Up to 12X	
		DVD+RW	Up to 8X	
		DVD-RW	Up to 8X	
		DVD+R DL	Up to 8X	
		DVD-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		DVD-ROM DL	Up to 8X	
		DVD+R	Up to 16X	
		DVD-R	Up to 16X	
Power	Source	SATA DC power recepta	er receptacle	
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p		
	DC Current	5 VDC -1000 mA typical, 1600 mA maximum 12 VDC -600 mA typical, 1400 mA maximum		
<b>Operating Environmental</b> (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)		
	<b>Relative Humidity</b>	10% to 90%		
	Maximum Wet Bulb Temperature	86° F (30° C)		
	Operating Systems Supported	Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS4**, 5, 6 Desktop/Workstation SUSE Linux Enterprise Desktop 10 & 11		
	Kit Contents	No driver is required for support is provided by t HP SATA SuperMulti DVI Easy Media Creator soft	he operating system. D Writer Drive, Roxio	

WinDVD Software, installation guide, and

DVD+R media.

**HP Blu-Ray Writer** 

**Description**5.25-inch, half-height, tray-load**Mounting Orientation**Either horizontal or verticalInterface TypeSATA**Dimensions** (WxHxD)15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

**Disc Formats** BD-ROM

BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW



### Technical Specifications - Optical and Removable Storage

	CD-R		
<b></b> .	CD-RW		
Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB star	
	Blu-ray	50 GB DL or 25 GB stand	dard
	Full Stroke DVD	< 250 ms (seek)	
	Full Stroke CD	< 210 ms (seek)	
	Blu-ray	Blu-ray	
	Startup Time (Time to	BD-ROM (SL/DL)	255 / 285
	drive ready from tray loading)	BD-R (SL/DL)	255 / 285
	todding,	BD-RE (SL/DL)	255 / 285
		DVD-ROM (SL/DL)	185 / 185
		DVD-R (SL/DL)	255 / 255
		DVD-RW	255
		DVD+R (SL/DL)	255 / 255
		DVD+RW	255
		DVD-RAM	45S
		CD-ROM	45S
Maximum Data Transfer	CD ROM Read	CD-ROM CD-R	Up to 40X
Rates		CD-RW	Up to 40X Up to 40X
	DVD ROM Read	DVD-RAM	Up to 5X
		DVD+RW	Up to 10X
		DVD-RW	Up to 10X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-ROM	Up to 16X
		DVD-ROM DL	Up to 8X
		DVD+R	Up to 12X
		DVD-R	Up to 12X
	Blu-Ray	BD-ROM	Up to 6X
	-	BD-ROM DL	Up to 4.8X
		BD-R	Up to 6X
		BD-R DL	Up to 4.8X
		BD-R	Up to 6X
		BD-RE SL/DL	Up to 4.8X
Power	Source	SATA DC power recepta	cle
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 10%-100 mV ripple p-p	
	DC Current	5 VDC -900 mA typical, 1200 mA maximum 12 VDC -1000 mA typical, 1600 mA maximum	
Operating Environmental	Temperature	41° to 122° F (5° to 50° C)	
(all conditions non-	Relative Humidity	15% to 80%	
condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	
	Operating Systems Supported	Windows 7 Professiona Windows Vista Business	•

### Technical Specifications - Optical and Removable Storage

Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP Professional or

Windows XP Home 32\*.

Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, 6

Desktop/Workstation.

SUSE Linux Enterprise Desktop 10 & 11

\* No driver is required for this device. Native support is provided by the operating system.

\*\* RHEL WS4 not supported on Z200/Z200SFF

Kit Contents HP Blue Laser RW Drive, Roxio Easy Media

Creator software, Intervideo WinDVD Software,

installation guide.

**Disclaimer** As Blu-Ray is a new format containing new technologies, certain disc,

digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

HP 22-in-1 Media Card Reader **Description** The Media Card Reader device uses the same physical form factor and

mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash

memory card formats that are supported.

Mounting Orientation The Media Card Reader can be mounted in a dedicated Floppy Drive bay (if

the chassis provides one) or in an appropriate Optical Bay adapter. It will

operate in any orientation.

**Interface Type** USB 2.0 (one channel dedicated to the separate USB port; one channel

dedicated to the flash memory card slots)

**Dimensions** (WxHxD)

**Disc Formats** 

124.5 x 101.6 x 25.4 mm (4.9 x 4.0 x 1.0 in)

Picture Micro SD

Micro SDHC

SD SDHC SDXC Mini SD

Mini SDHC MultiMediaCard

Reduced Size MultiMediaCard (RS MultiMediaCard)

MultiMedia Card 4.2 (MultiMediaCard Plus, including MultiMediaCard Plus

HC)

Reduced Size MultiMedia Card 4.2 (MultiMediaCard Mobile, including

MultiMediaCard Mobile HC) CompactFlash Card Type I CompactFlash Card Type II

MicroDrive

Memory Stick (MS)

MagicGate Memory Stick (MG)
MagicGate Memory Stick Duo
Memory Stick Select

Memory Stick Select Memory Stick Duo (MS Duo)

### Technical Specifications - Optical and Removable Storage

Memory Stick PRO (MS PRO) Memory Stick PRO Duo (MS PRO Duo) Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied): MultiMediaCard Micro Memory Stick Micro (M2)



#### Technical Specifications - Controller Cards

**HP IEEE 1394b FireWire PCIe Card** 

**Data Transfer Rate** Supports up to 800 Mbps **Devices Supported** IEEE-1394 compliant devices **Bus Type** PCIe card full height PCIe slots

**Ports** Two IEEE-1394b bilingual 9-Pin Connector (Rear)

**Internal Connectors** One 10-Pin header Custom Connector

**System Requirements** Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP

> Professional, Windows XP Home, Windows Vista, SLED 11 and RHEL 6. Intel Pentium® G series or higher processor, 128-MB RAM, 1-GB Hard Drive, CD-

ROM drive, built in sound system, Available PCIe slot.

Temperature - Operating 50° to 131° F (10° to 55° C)

Temperature – Storage -22° to 140° F (-30° to 60° C)

Relative Humidity -

20% to 80% **Operating** 

**Compliances** 

FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit and 64-bit, Windows® XP Professional, XP Professional 64-bit, RHEL 6 and

**SLED 11.** 

HP USB 3.0 2x2 Port SuperSpeed PCIe x1 Card

**Dimensions** (HxD)

**TBD Ports** 

**Operating Systems** Supported

2 External, 2 internal

Microsoft Windows 7. Windows Vista\*. Windows XP Professional (32-bit and 64-bit); Red Hat Enterprise Linux 6, SUSE Linux Enterprise Desktop 11 Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista

system requirements, visit:

http://www.windowsvista.com/systemrequirements.

**Kit Contents** 

I/O and Security Software and Documentation CD with software drivers and documentation, HP SuperSpeed USB 3.0 PCIe x1 card (with full-height expansion bracket attached), SATA to SATA split power extension cable. Low profile expansion bracket to replace the full-height expansion bracket required on some computer models and HP SuperSpeed USB 3.0 PCIe x1

Card Ouick Setup.

**Regulatory Approvals** and registrations

FCC 15B, CE EN55022+ EN55024, VCCI, CISPR 22 AS/NZS CISPR 22, LCIE CB service(ITE/AV) IEC 60950-1, Korea EMC, UL USB-IF

Weight Warranty 0.21 lb (95.0 q)

The HP USB 3.0 2x2 Port Super Speed PCIe x1 Card has either a one-year limited warranty or the remainder of the warranty of the HP product in

which it is installed. Technical support is available seven days a week, 24 hours a day, by phone, as well as online support forums. Certain

restrictions and exclusions apply.

### Technical Specifications - Networking and Communications

Integrated Intel 82579LM Connector RJ-45

**PCIe GbE Controller** 

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

**Compliance** 802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u

**Bus Architecture** PCI Express and SMBus

**Data Transfer Mode** PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx low power state)

**Power Requirement** Requires 3.3V and 1.05V or just 3.3V with integrated regulators

**Boot ROM Support** Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

**Network Transfer Rate** 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostic. AMT 7.0 support

Intel Gigabit CT Desktop NIC

**Connector** RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

**Data Rates Supported** 10/100/1000 Mbps

**Compliance** IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x

flow control

**Bus Architecture** PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

**Data Transfer Mode** Bus-master DMA

Hardware Certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for

**European Union** 

**Power Requirement** Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

**Boot ROM Support** Ye

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

**Operating Temperature** 32° to 131°F (0° to 55° C) **Operating Humidity** 85% at 131° F (55° C)

**Dimensions** 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)

**Operating System Driver** 

Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64, Windows Vista Business 32, Windows XP Professional, Windows XP x64.

Red Hat Enterprise Linux 4 (RHEL4.8 or newer)\*, Red Hat Enterprise Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6, SUSE Linux Enterprise

Desktop (SLED) 11

**Technical Specifications - Networking and Communications** 

RHEL 4 and 5, SLED 10, are not supported on the Z220 CMT/SFF

Management Capabilities WOL, PXE, DMI, WFM 2.0

**Kit Contents** Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel

PROset II NIC drivers, quick install guide, product warranty statement



### **Summary of Changes**

Date of change:	Version History:		Description of change:
November 1, 2014	From v21 to v22	Removed	Windows 7 Home and Windows 7 Ultimate
February 1, 2015	From v22 to v23	Changed	Overview, Chassis Dimensions
April 1, 2015	From v23 to v24	Changed	Memory nomenclature throughout the document.



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